

30V,5.2A N-Channel Power MOSFET

GENERAL DESCRIPTION

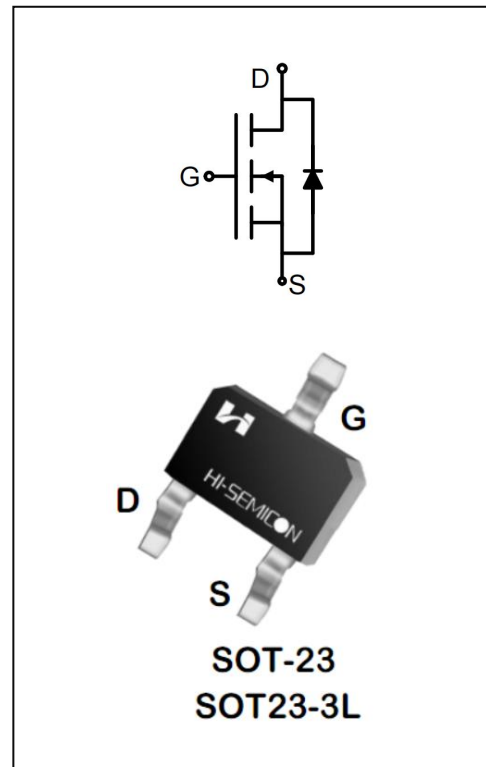
The SFS3400 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

Features

- ◆ $V_{DS}=30V, I_D=5.2A$
- ◆ $R_{DS(ON)}$
 - TYP:24.0mΩ@ $V_{GS}= 10V, I_D= 4.0A$
 - TYP:27.5mΩ@ $V_{GS}= 4.5V, I_D= 3.0A$
 - TYP:34.5mΩ@ $V_{GS}= 2.5V, I_D= 3.0A$

Applications

- ◆ Power faction correction (PFC)
- ◆ Switched mode power supplies (SMPS)
- ◆ Uninterruptible power supply (UPS)
- ◆ LED lighting power



ORDERING INFORMATION

Part No.	Package	Marking	Material	Packing
SFS3400	SOT23-3L/SOT-23	3400A	Pb Free	Reel

ABSOLUTE MAXIMUM RATINGS (T_J=25°C unless otherwise noted)

Characteristics		Symbol	Ratings	Unit
Drain-Source Voltage		V _{DS}	30	V
Gate-Source Voltage		V _{GS}	±12	V
Drain Current	T _C = 25°C	I _D	5.2	A
	T _C = 75°C		4.1	
Drain Current Pulsed(Note 1)		I _{DM}	21	A
Power Dissipation(T _C =25°C) -Derate above 25°C		P _D	1.36	W
Operation Junction Temperature Range		T _J	-55~+150	°C
Storage Temperature Range		T _{stg}	-55~+150	°C
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		TL	300	°C

ELECTRICAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain -Source Breakdown Voltage	B _{VDS}	V _{GS} = 0V, I _D = 250μA	30	--	--	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} = 30V, V _{GS} = 0V	--	--	1	μA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = 12V, V _{DS} = 0V	--	--	100	nA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = -12V, V _{DS} = 0V	--	--	-100	
On Characteristics						
Gate Threshold Voltage	V _{GS(th)}	V _{GS} = V _{DS} , I _D = 250μA	0.5	0.8	1.3	V
Static Drain- Source On State Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 4.0A	--	24.0	30	mΩ
		V _{GS} = 4.5V, I _D = 3.0A	--	27.5	35	
		V _{GS} = 2.5V, I _D = 3.0A	--	34.5	50	
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} = 15V V _{GS} = 0V f=1.0MHZ	--	560	--	pF
Output Capacitance	C _{oss}		--	50	--	
Reverse Transfer Capacitance	C _{rss}		--	45	--	
Switching Characteristics						
Turn-on Delay Time	t _{d(on)}	V _{DD} = 15V, V _{GS} = 10V R _G = 3Ω, I _D = 3.0A (Note 2.3)	--	4.7	--	nS
Turn-on Rise Time	t _r		--	4.1	--	
Turn-off Delay Time	t _{d(off)}		--	22.3	--	
Turn-off Fall Time	t _f		--	3.2	--	
Total Gate Charge	Q _g	V _{DS} =15V, I _D =4A V _{GS} =4.5V	--	9.2	--	nC
Gate-Source Charge	Q _{gs}		--	1.6	--	
Gate-Drain Charge	Q _{gd}		--	3.1	--	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	I_S	Integral Reverse P-N Junction Diode in the MOSFET	--	--	5.2	A
Pulsed Source Current	I_{SM}		--	--	21	
Diode Forward Voltage	V_{SD}	$I_S = 3A, V_{GS} = 0V$	--	0.8	-1.2	V

NOTE:

- 1.Pulse width limited by maximum junction temperature
- 2.Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$
- 3.Essentially independent of operating temperature

Typical Performance Characteristics

Figure 1. Output Characteristics

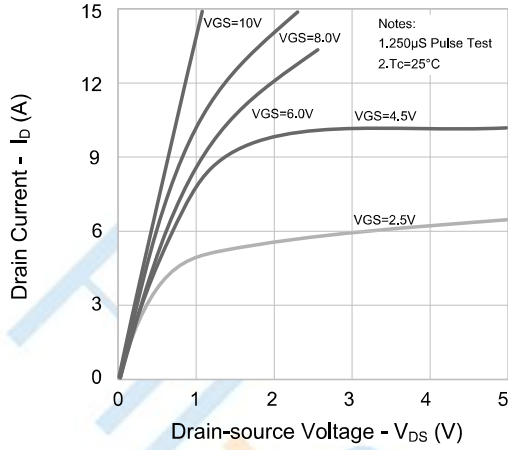


Figure 2. Transfer Characteristics

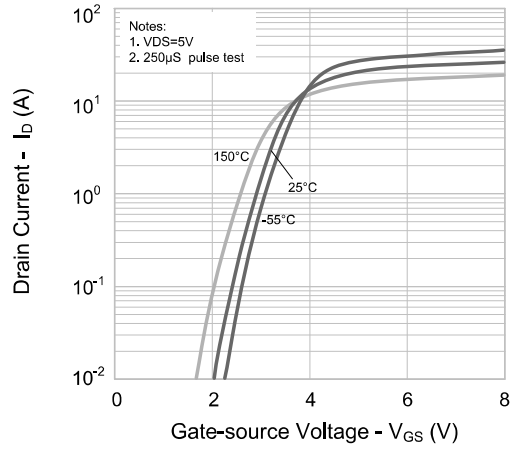


Figure 3. On-resistance vs. Drain Current

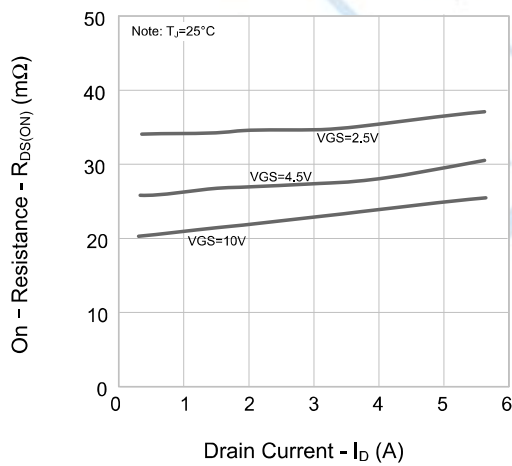


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

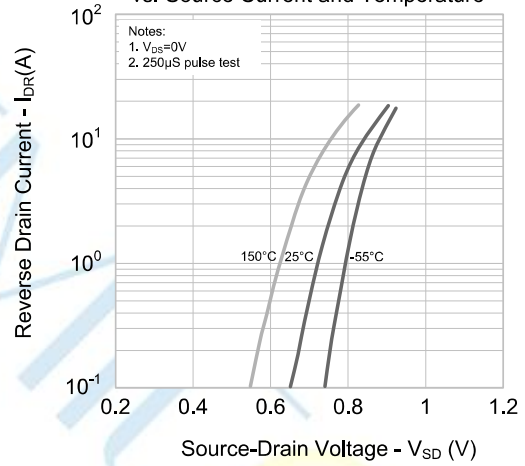


Figure 5. Capacitance Characteristics

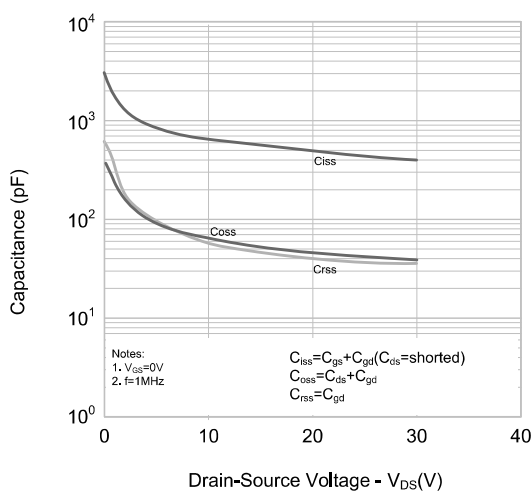
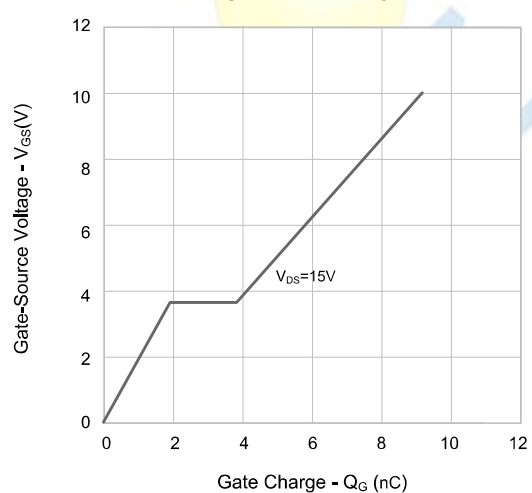
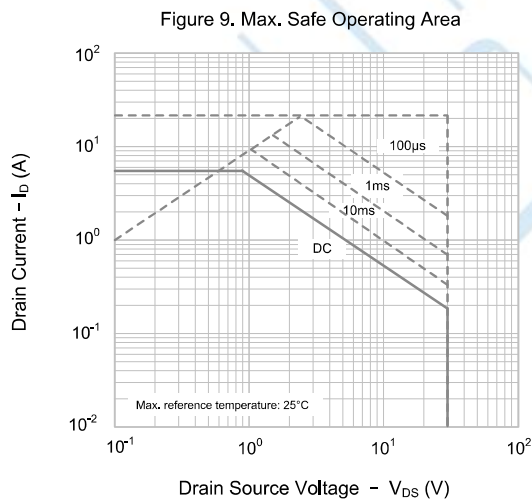
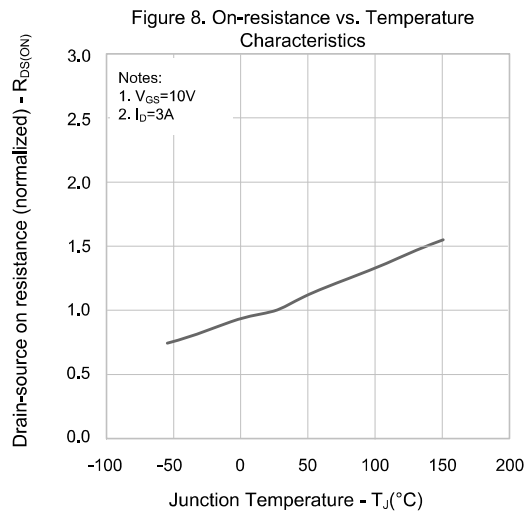
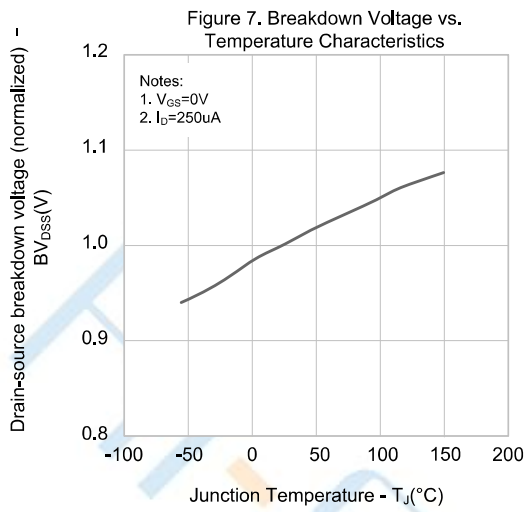


Figure 6. Gate Charge

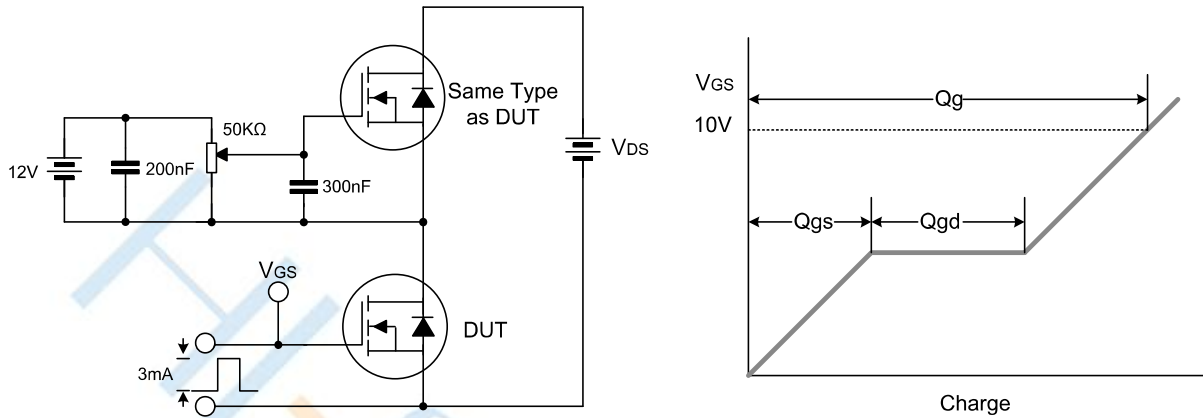


Typical Performance Characteristics

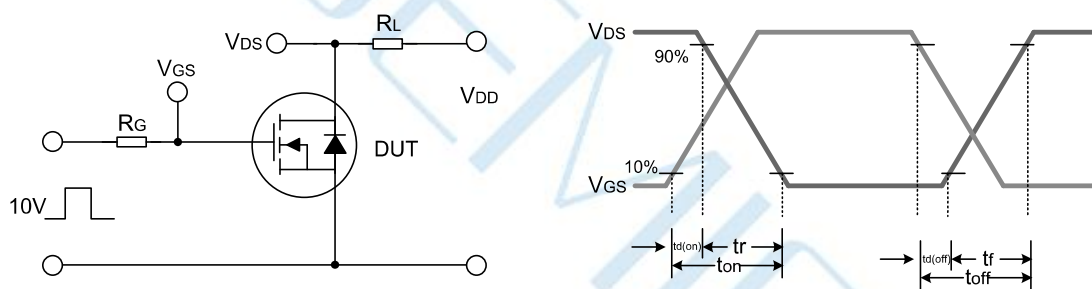


Test Circuit

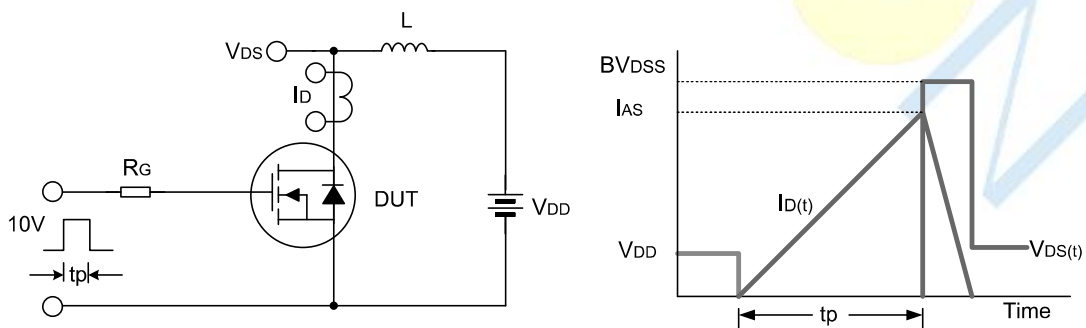
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform

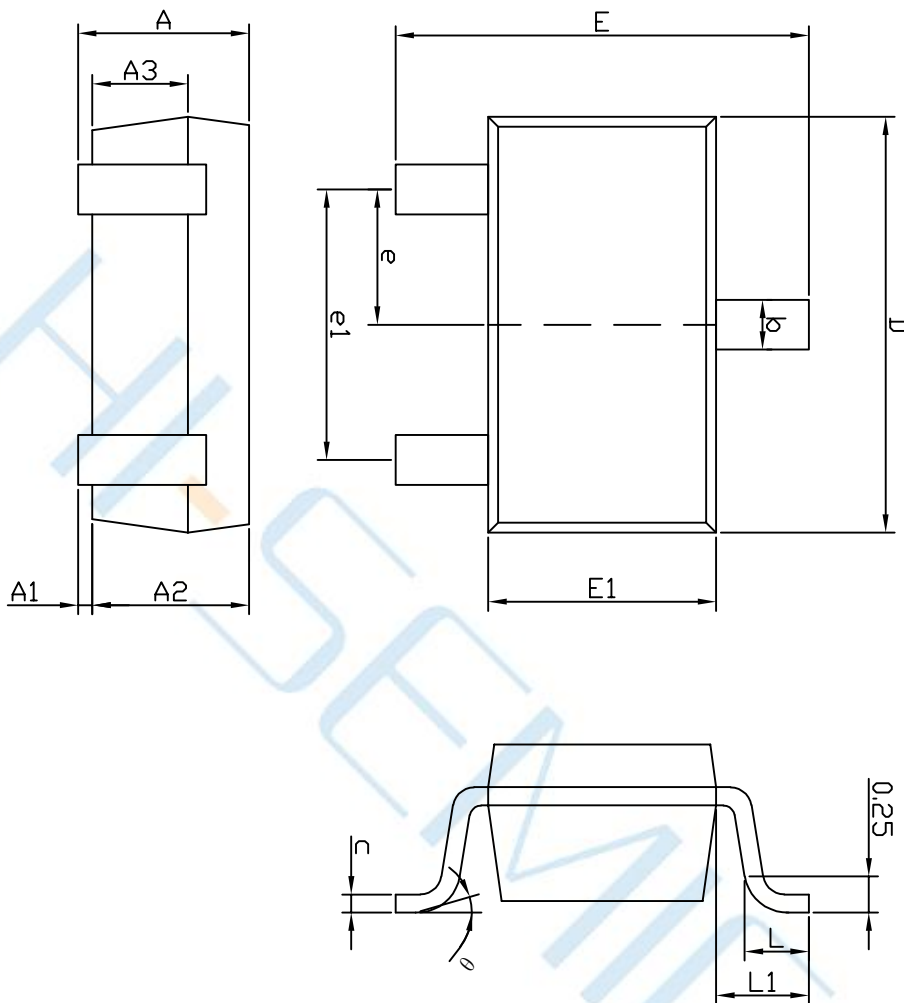


Unclamped Inductive Switching Test Circuit & Waveform



Package Dimensions of SOT23-3L

Unit:mm

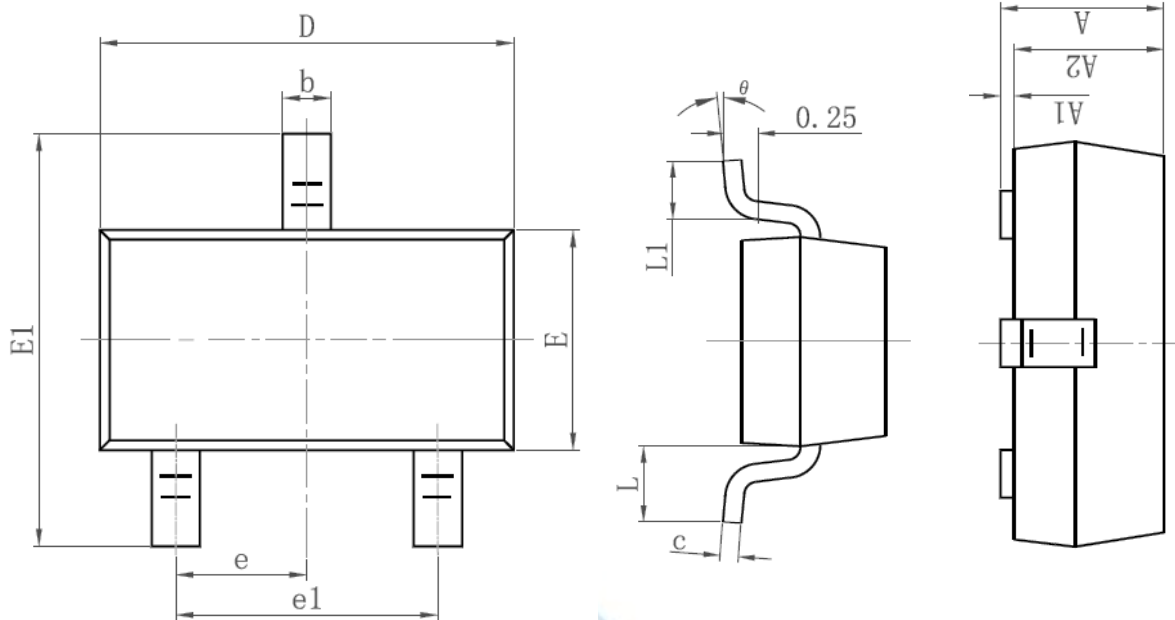


COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX
A	-	-	1.25
A1	0.04	-	0.10
A2	1.00	1.10	1.20
A3	0.60	0.65	0.70
b	0.33	-	0.41
c	0.11	-	0.20
D	2.82	2.92	3.02
E	2.60	2.80	3.00
E1	1.50	1.60	1.70
e	0.95BSC		
e1	1.90BSC		
L	0.30	-	0.60
L1	0.60REF		
θ	0°	-	8°

Package Dimensions of SOT-23

Unit:mm



Symbol	Dimensions in Millimeters	
	MIN.	MAX.
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
e	0.950TYP	
e1	1.800	2.000
L	0.550REF	
L1	0.300	0.500
θ	0°	8°

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